

Amendments to the Claims:

This listing of claims will replace all prior versions, and listings, of claims in the application:

Listing of Claims:

Claims 1 – 6 (Cancelled)

7. (New) A cationic polymerizable adhesive composition comprising:

(a) a cationic polymerizable monomer selected from an epoxy monomer, a vinyl ether monomer, or a mixture thereof;

(b) a cationic polymerization catalyst being an iron-arene complex having an absorption peak in a visible light range of from 360 to 830 nm; and

(c) a solvent for the cationic polymerization catalyst,
wherein the solvent is a mixture of a good solvent and a poor solvent for the cationic polymerization catalyst.

8. (New) The cationic polymerizable adhesive composition as claimed in claim 7, wherein a weight ratio of the good solvent to the poor solvent is within a range from 5:95 to 60:40.

9. (New) An anisotropically electroconductive adhesive composition comprising the cationic polymerizable adhesive composition claimed in claim 7 and electroconductive particles.

10. (New) An adhesive film formed by applying the cationic polymerizable adhesive composition claimed in claim 7 onto a separator and drying the coating film.

11. (New) An anisotropically electroconductive adhesive film formed by applying the anisotropically electroconductive adhesive composition claimed in claim 9 onto a separator and drying the coating film.

12. (New) An anisotropically electroconductive adhesive composition comprising a cationic polymerizable adhesive composition comprising:

(a) a cationic polymerizable monomer selected from an epoxy monomer, a vinyl ether monomer, or a mixture thereof;

(b) a cationic polymerization catalyst; and

(c) a solvent for the cationic polymerization catalyst,

wherein the solvent is a mixture of a good solvent and a poor solvent for the cationic polymerization catalyst; and electroconductive particles.